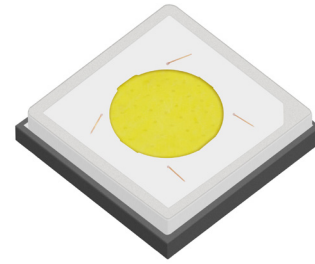


SFT-25R-WES-A

High Power White LEDs



Features

With Luminus' advanced chip and packaging technologies, SFT-25R-W maximizes the Candela/Lumen K-Factor for high optical performance in directional lighting:

- A small emitter enables high intensity, long beam distance and small optics.
- A patented round emitter, in comparison with a square emitter, enables better uniformity and higher intensity in beam spots.
- A flat window, in comparison with a domed cover, allows the optics to be closer to the emitter to achieve higher intensity and longer beam distance.

In addition, Luminus phosphor-on-chip technology's high uniformity of color over radiation angle enables superior beam spot light quality.

- Package Size: 3535
- Maximum Drive Current: 7.5 A
- Color Temperature: 5000K, 5700K, 6500K
- Color Rendering Index: Min. 70 (5000K, 5700K), Typ.70 (6500K)
- Low thermal resistance: 0.8 °C/W
- ANSI-compatible chromaticity bins
- Electrically isolated thermal path
- 8 kV HBM ESD rating per ANSI/ESDA/JEDEC JS-001

Applications

- Portable Lights
- Bicycle Lights
- Transportation Lighting
- LED Work Lights
- Outdoor and Roadway Lighting
- Industrial Lighting

Table of Contents

| | |
|------------------------------------|----|
| Ordering Information. | 2 |
| Binning Structure. | 3 |
| Absolute Maximum Ratings | 6 |
| Characteristics | 6 |
| Soldering Profile. | 10 |
| Mechanical Dimensions. | 11 |
| Tape and Reel Outline | 12 |
| Shipping Label | 13 |
| Packaging | 14 |
| Notes | 15 |





Ordering Information

Ordering Part Numbers¹

| CRI | CCT | Luminous Flux | | Chromaticity Bin Kit ³ | Ordering Part Numbers |
|--------------------|-------|-------------------------------|---------------------------|-----------------------------------|-----------------------|
| | | Minimum Flux Bin ¹ | Minimum Flux ² | | |
| Min. 70 | 5000K | F8 | 610 lm | 501 | SFT-25R-WE50-A2-F8501 |
| | | | | 502 | SFT-25R-WE50-A2-F8502 |
| | | F9 | 640 lm | 501 | SFT-25R-WE50-A2-F9501 |
| | | | | 502 | SFT-25R-WE50-A2-F9502 |
| | 5700K | F8 | 610 lm | 571 | SFT-25R-WE57-A2-F8571 |
| | | | | 572 | SFT-25R-WE57-A2-F8572 |
| | | F9 | 640 lm | 571 | SFT-25R-WE57-A2-F9571 |
| | | | | 572 | SFT-25R-WE57-A2-F9572 |
| Typ. 70 Min. 65 | 6500K | F8 | 610 lm | 651 | SFT-25R-WS65-A2-F8651 |
| | | | | 652 | SFT-25R-WS65-A2-F8652 |
| | | | | 703 | SFT-25R-WS65-A2-F8703 |
| | | F9 | 640 lm | 651 | SFT-25R-WS65-A2-F9651 |
| | | | | 652 | SFT-25R-WS65-A2-F9652 |

Part Number Nomenclature

SFT

25R

W<xy>

<p#>

<ffcc>

| Product Family | Chip Area | Color | Package Configuration | Bin Kit |
|--|---|--|---|--|
| S: Surface Mount F: Flat Window T: Single Emitter | 25: 2.5 mm ² R: Round Shape | W: White <x> CRI Category Code E: CRI>70 S: CRI>65 <yy> Color Temperature 50: 5000K 65: 6500K | <p> Solder Pad Configuration A: 3535 with type A solder pad - see page 10 <#> Chip Generation 2: Gen 2 | <ff> Minimum Flux Bin, see 'Luminous Flux Binning' table for details <ccc> Chromaticity Bin Kit, see 'Chromaticity Bin Kit Codes' table for details |

Note:

- The Ordering Part Number specifies the Minimum Flux Bin in shipment; higher flux bins may be shipped without advance notice. Please refer to 'Luminous Flux Binning' table for details of all flux bins.
- Product test condition: $I_f = 1500 \text{ mA}$, $T_j = 85^\circ\text{C}$.
- Shipments always adhere to the color bins specified in each Chromaticity Bin Kit. See 'Chromaticity Bin Kit Codes' table for the color bins included in each Bin Kit.



Binning Structure

Luminous Flux Binning^{1,2}

| Flux Bin Code | Binning @ 1500 mA | | | Correlated Minimum Flux (lm) @ $T_j=85^\circ\text{C}^2$ | | | | |
|---------------|--------------------------|-------------------|--------------------------|---|---------|---------|---------|---------|
| | $T_j=85^\circ\text{C}^1$ | | $T_j=25^\circ\text{C}^1$ | 700 mA | 2000 mA | 3000 mA | 5000 mA | 7500 mA |
| | Minimum Flux (lm) | Maximum Flux (lm) | Minimum Flux (lm) | | | | | |
| F7 | 580 | 610 | 650 | 290 | 737 | 1009 | 1450 | 1839 |
| F8 | 610 | 640 | 683 | 305 | 775 | 1061 | 1525 | 1934 |
| F9 | 640 | 680 | 717 | 320 | 813 | 1114 | 1600 | 2029 |
| G1 | 680 | 720 | 762 | 340 | 864 | 1183 | 1700 | 2156 |
| G2 | 720 | 760 | 806 | 360 | 914 | 1253 | 1800 | 2282 |

Forward Voltage Binning³

| Voltage Bin Code | Binning @ 1500 mA, $T_j = 85^\circ\text{C}$ | |
|------------------|---|---------------------|
| | Minimum Voltage (V) | Maximum Voltage (V) |
| VJ | 2.7 | 2.9 |
| VK | 2.9 | 3.1 |
| VL | 3.1 | 3.3 |

Note:

- LEDs are measured at 25°C ambient temperature with 1500 mA 20 ms single pulse. The measured values are correlated to values at 85°C junction temperature (T_j). Luminus maintains a $\pm 6\%$ tolerance on flux measurement.
- Flux values at other junction temperature (T_j) and/or forward current conditions are calculated and for reference only.
- Individual voltage bins are not orderable.



Binning Structure

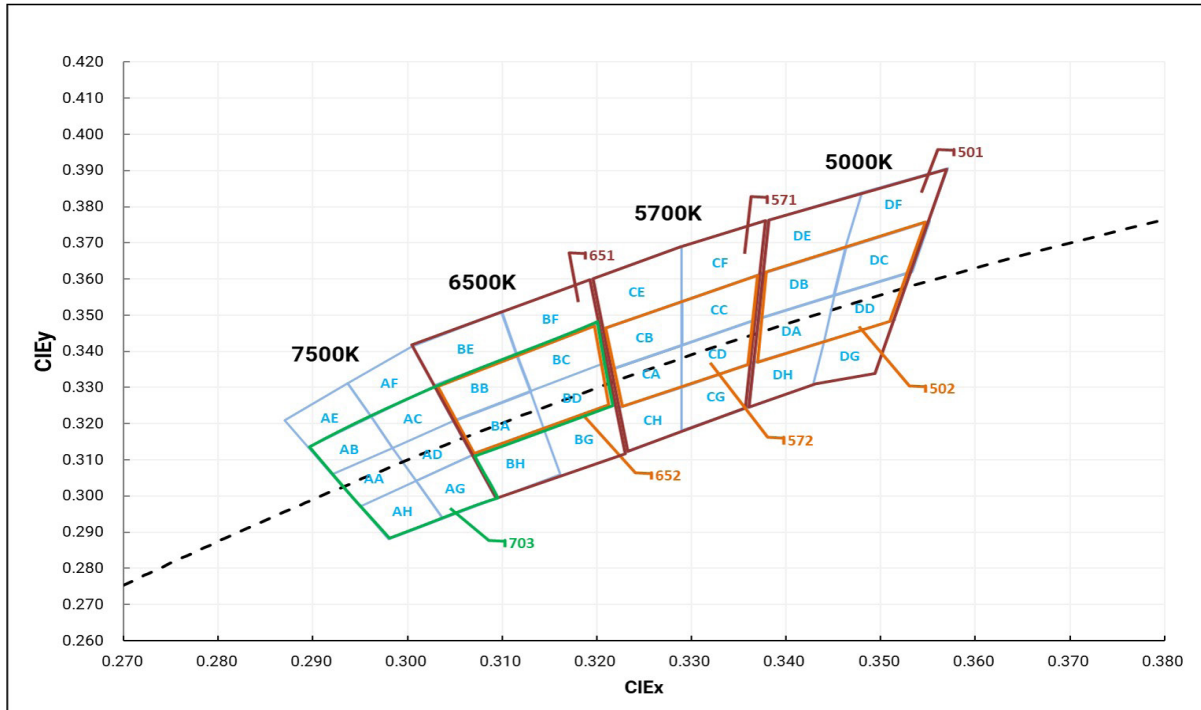
Chromaticity Binning Coordinates

| CCT | Bin Code | CIE _x | CIE _y | Bin Code | CIE _x | CIE _y | Bin Code | CIE _x | CIE _y | Bin Code | CIE _x | CIE _y |
|-------|----------|------------------|------------------|----------|------------------|------------------|----------|------------------|------------------|----------|------------------|------------------|
| 5000K | DA | 0.3371 | 0.3490 | DB | 0.3376 | 0.3616 | DC | 0.3463 | 0.3687 | DD | 0.3451 | 0.3554 |
| | | 0.3451 | 0.3554 | | 0.3463 | 0.3687 | | 0.3551 | 0.3760 | | 0.3533 | 0.3620 |
| | | 0.3440 | 0.3427 | | 0.3451 | 0.3554 | | 0.3533 | 0.3620 | | 0.3515 | 0.3487 |
| | | 0.3366 | 0.3369 | | 0.3371 | 0.3490 | | 0.3451 | 0.3554 | | 0.3440 | 0.3427 |
| | DH | 0.3366 | 0.3369 | DE | 0.3381 | 0.3762 | DF | 0.3480 | 0.3840 | DG | 0.3440 | 0.3428 |
| | | 0.3440 | 0.3428 | | 0.3480 | 0.3840 | | 0.3571 | 0.3907 | | 0.3515 | 0.3487 |
| | | 0.3429 | 0.3307 | | 0.3463 | 0.3687 | | 0.3551 | 0.3760 | | 0.3495 | 0.3339 |
| | | 0.3361 | 0.3245 | | 0.3376 | 0.3616 | | 0.3463 | 0.3687 | | 0.3429 | 0.3307 |
| 5700K | CA | 0.3215 | 0.3350 | CB | 0.3207 | 0.3462 | CC | 0.3290 | 0.3538 | CD | 0.3290 | 0.3417 |
| | | 0.3290 | 0.3417 | | 0.3290 | 0.3538 | | 0.3376 | 0.3616 | | 0.3371 | 0.3490 |
| | | 0.3290 | 0.3300 | | 0.3290 | 0.3417 | | 0.3371 | 0.3490 | | 0.3366 | 0.3369 |
| | | 0.3222 | 0.3243 | | 0.3215 | 0.3350 | | 0.3290 | 0.3417 | | 0.3290 | 0.3300 |
| | CH | 0.3222 | 0.3243 | CE | 0.3196 | 0.3602 | CF | 0.3290 | 0.3690 | CG | 0.3290 | 0.3300 |
| | | 0.3290 | 0.3300 | | 0.3290 | 0.3690 | | 0.3381 | 0.3762 | | 0.3366 | 0.3369 |
| | | 0.3290 | 0.3180 | | 0.3290 | 0.3538 | | 0.3376 | 0.3616 | | 0.3361 | 0.3245 |
| | | 0.3231 | 0.3120 | | 0.3207 | 0.3462 | | 0.3290 | 0.3538 | | 0.3290 | 0.3180 |
| 6500K | BA | 0.3048 | 0.3207 | BB | 0.3028 | 0.3304 | BC | 0.3115 | 0.3391 | BD | 0.3130 | 0.3290 |
| | | 0.3130 | 0.3290 | | 0.3115 | 0.3391 | | 0.3205 | 0.3481 | | 0.3213 | 0.3373 |
| | | 0.3144 | 0.3186 | | 0.3130 | 0.3290 | | 0.3213 | 0.3373 | | 0.3221 | 0.3261 |
| | | 0.3068 | 0.3113 | | 0.3048 | 0.3207 | | 0.3130 | 0.3290 | | 0.3144 | 0.3186 |
| | BH | 0.3068 | 0.3113 | BE | 0.3005 | 0.3415 | BF | 0.3099 | 0.3509 | BG | 0.3144 | 0.3186 |
| | | 0.3144 | 0.3186 | | 0.3099 | 0.3509 | | 0.3196 | 0.3602 | | 0.3221 | 0.3261 |
| | | 0.3161 | 0.3059 | | 0.3115 | 0.3391 | | 0.3205 | 0.3481 | | 0.3231 | 0.3120 |
| | | 0.3093 | 0.2993 | | 0.3028 | 0.3304 | | 0.3115 | 0.3391 | | 0.3161 | 0.3059 |
| 7500K | AA | 0.2950 | 0.297 | AB | 0.2920 | 0.3060 | AC | 0.2984 | 0.3133 | AD | 0.2984 | 0.3133 |
| | | 0.2920 | 0.306 | | 0.2895 | 0.3135 | | 0.2962 | 0.3220 | | 0.3048 | 0.3207 |
| | | 0.2984 | 0.3133 | | 0.2962 | 0.3220 | | 0.3028 | 0.3304 | | 0.3068 | 0.3113 |
| | | 0.3009 | 0.3042 | | 0.2984 | 0.3133 | | 0.3048 | 0.3207 | | 0.3009 | 0.3042 |
| | AH | 0.2980 | 0.2880 | AE | 0.2895 | 0.3135 | AF | 0.2962 | 0.3220 | AG | 0.3037 | 0.2937 |
| | | 0.2950 | 0.2970 | | 0.2870 | 0.3210 | | 0.2937 | 0.3312 | | 0.3009 | 0.3042 |
| | | 0.3009 | 0.3042 | | 0.2937 | 0.3312 | | 0.3005 | 0.3415 | | 0.3068 | 0.3113 |
| | | 0.3037 | 0.2937 | | 0.2962 | 0.3220 | | 0.3028 | 0.3304 | | 0.3093 | 0.2993 |



Binning Structure

Chromaticity Binning Diagram^{1,2}



Chromaticity Bin Kit Codes

| CCT | Bin Kit | Chromaticity Bins |
|---------------|---------|--|
| 5000K | 501 | DA, DB, DC, DD, DE, DF, DG, DH |
| | 502 | DA, DB, DC, DD |
| 5700K | 571 | CA, CB, CC, CD, CE, CF, CG, CH |
| | 572 | CA, CB, CC, CD |
| 6500K | 651 | BA, BB, BC, BD, BE, BF, BG, BH |
| | 652 | BA, BB, BC, BD |
| 6500K - 7500K | 703 | AA, AB, AC, AD, AG, AH, BA, BB, BC, BD |

Note:

- LED chromaticity is measured and binned at 25°C ambient temperature with 1500 mA 20 ms single pulse.
- Luminus maintains a tolerance of ± 0.005 on Chromaticity (CIE_x, CIE_y) measurement.



Absolute Maximum Ratings

| Parameter | | Symbol | Value | | Unit |
|---|---------|-------------|------------------------------|------------------------------|------------------|
| | | | $T_j \leq 150^\circ\text{C}$ | $T_j \leq 130^\circ\text{C}$ | |
| DC Forward Current | Minimum | $I_{f\min}$ | 0.1 | | A |
| | Maximum | $I_{f\max}$ | 5.0 | 7.5 | |
| Surge Current ($t < 10$ ms, Duty Cycle $< 10\%$) | | I_s | 9.0 | | A |
| Reverse Voltage ($I_f = 10$ mA) | | V_r | 5 | | V |
| Power Dissipation | | P_D | 18 | 29 | W |
| Junction Temperature | | $T_{j\max}$ | 150 | | $^\circ\text{C}$ |
| Operating Temperature Range | | T_{opr} | -40 to 100 | | $^\circ\text{C}$ |
| Storage Temperature Range | | T_{stg} | -40 to 100 | | $^\circ\text{C}$ |
| ESD withstand Voltage HBM Per ANSI/ESDA/JEDEC JS-001 | | V_{HBM} | 8 | | kV |
| ESD withstand Voltage CDM Per ANSI/ESDA/JEDEC JS-002 | | V_{CDM} | 1 | | kV |

Characteristics

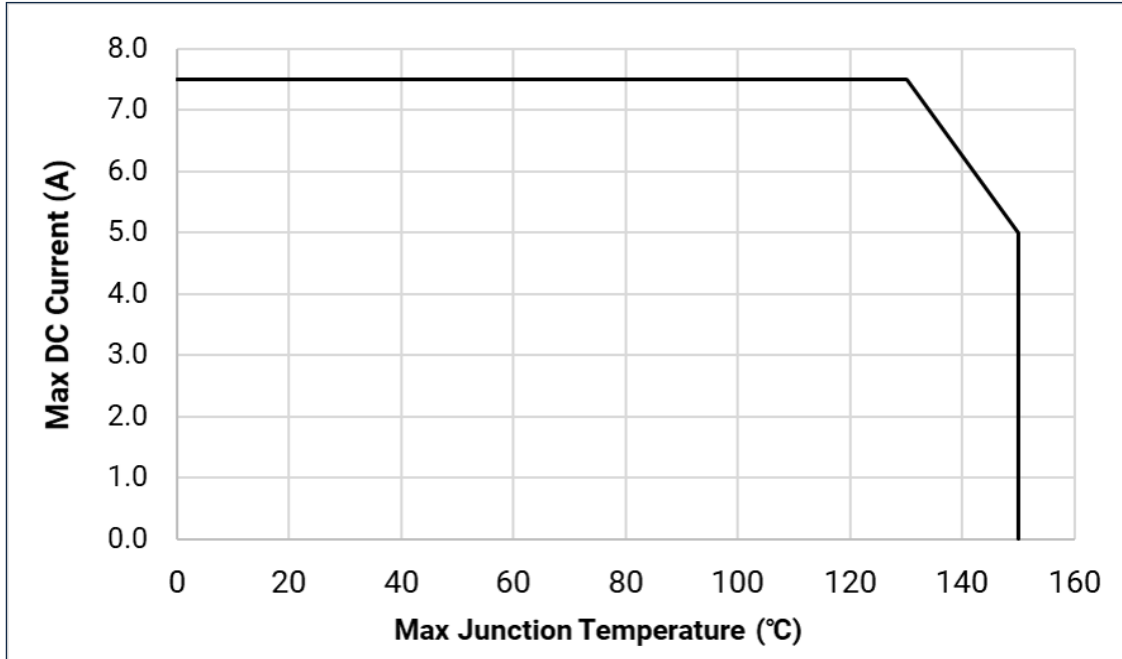
| Parameter | | Symbol | Value | | Unit |
|---|---------|-----------------------------|-------|----|---------------------------|
| | | | WS | WE | |
| Color Rendering Index ¹ ($T_j = 85^\circ\text{C}$) | Minimum | CRI_{\min} | 65 | 70 | |
| | Typical | CRI_{typ} | 70 | - | |
| Forward Voltage ($I_f = 1500$ mA, $T_j = 85^\circ\text{C}$) | Minimum | $V_{f\min}$ | 2.7 | | V |
| | Typical | $V_{f\text{typ}}$ | 2.9 | | |
| | Maximum | $V_{f\max}$ | 3.3 | | |
| Temperature Coefficient of Voltage | | $\partial V_f / \partial T$ | -1.4 | | mV/ $^\circ\text{C}$ |
| Viewing Angle (FWHM) | | $2\theta_{1/2}$ | 120 | | $^\circ$ |
| Thermal Resistance (Electrical) Junction/Solder Point | | $R_{\text{thjs-EL}}$ | 0.8 | | $^\circ\text{C}/\text{W}$ |

Note:

1. Luminus maintains a tolerance of ± 2 on Color Rendering Index (CRI) measurement.



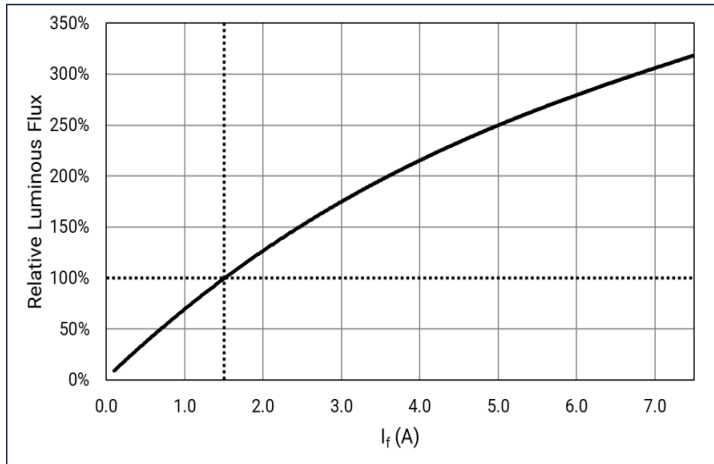
Maximum Permissible DC Current vs. Junction Temperature



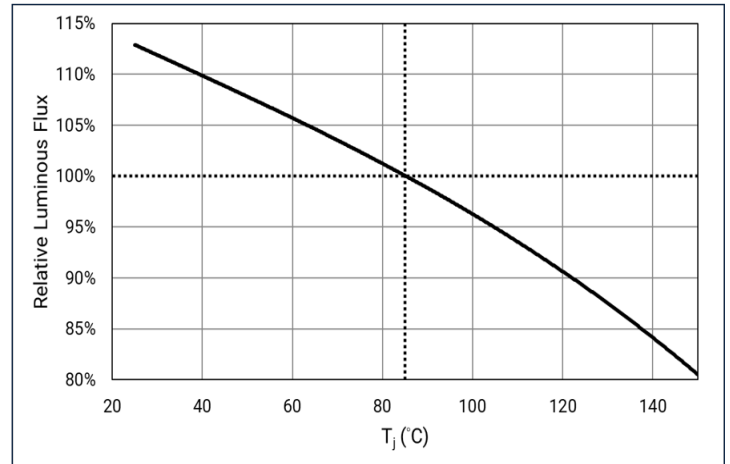


Relative Luminous Flux

Forward Current: $\phi_v/\phi_v(1500\text{ mA}), T_j = 85^\circ\text{C}$

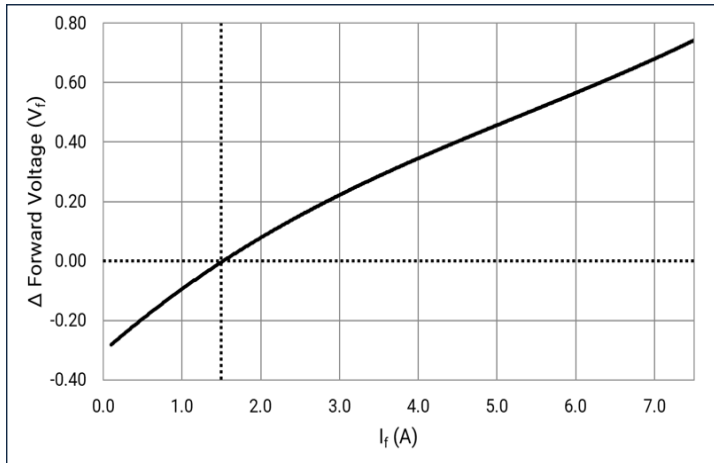


Temperature (T_j): $\phi_v/\phi_v(85^\circ\text{C}), I_f = 1500\text{ mA}$

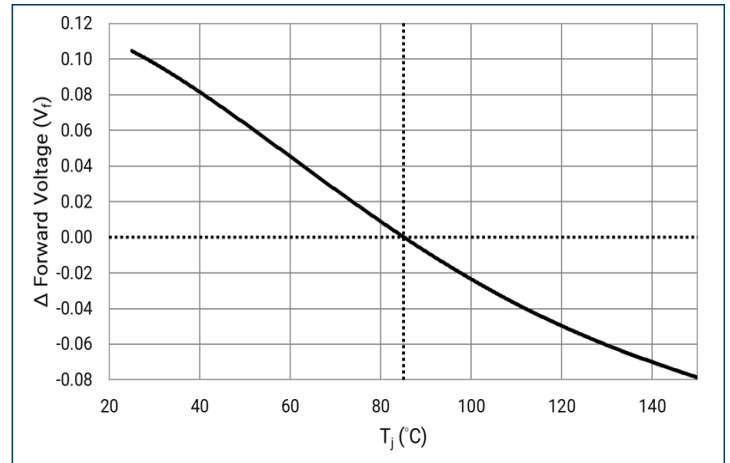


Forward Voltage

Forward Current: $\Delta V_f = V_f(I_f) - V_f(1500\text{ mA}), T_j = 85^\circ\text{C}$

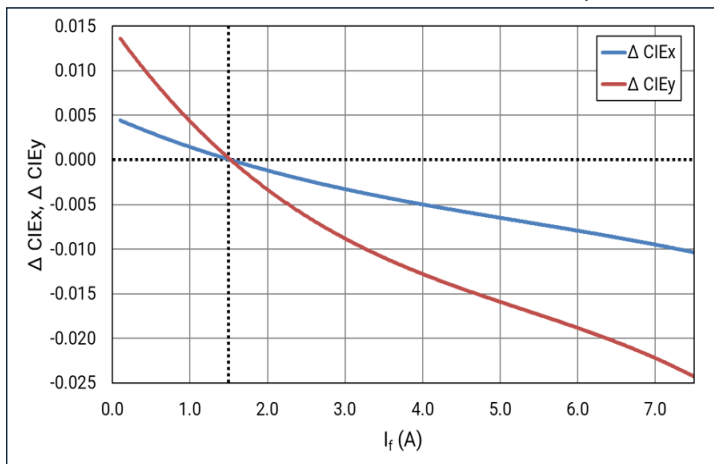


Temperature (T_j): $\Delta V_f = V(T_j) - V(85^\circ\text{C}), I_f = 1500\text{ mA}$

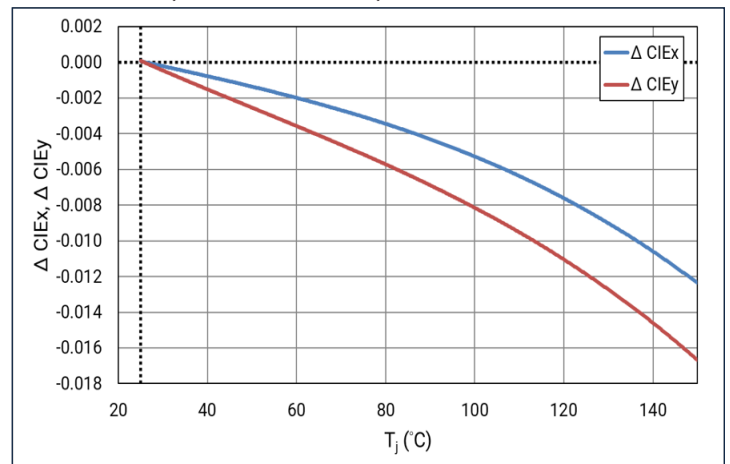


Relative Chromaticity

Forward Current: $\Delta \text{CIEx,y} = \text{CIEx,y}(I_f) - \text{CIEx,y}(1500\text{ mA}), T_j = 85^\circ\text{C}$



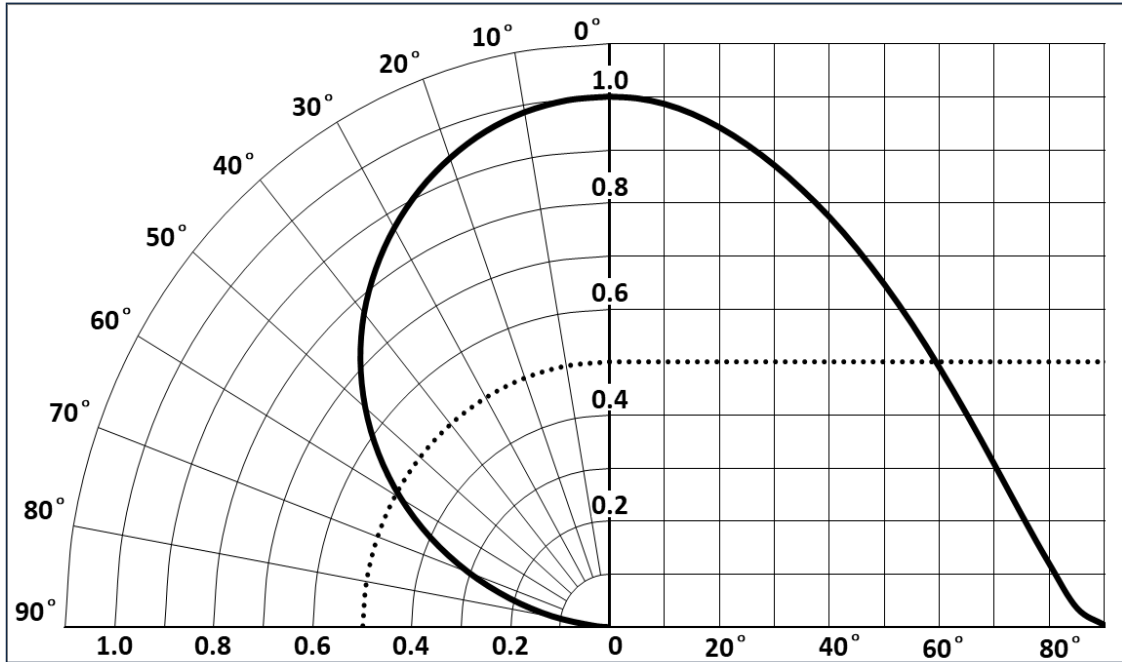
Temperature (T_j): $\Delta \text{CIEx,y} = \text{CIEx,y}(T_j) - \text{CIEx,y}(25^\circ\text{C}), I_f = 1500\text{ mA}$





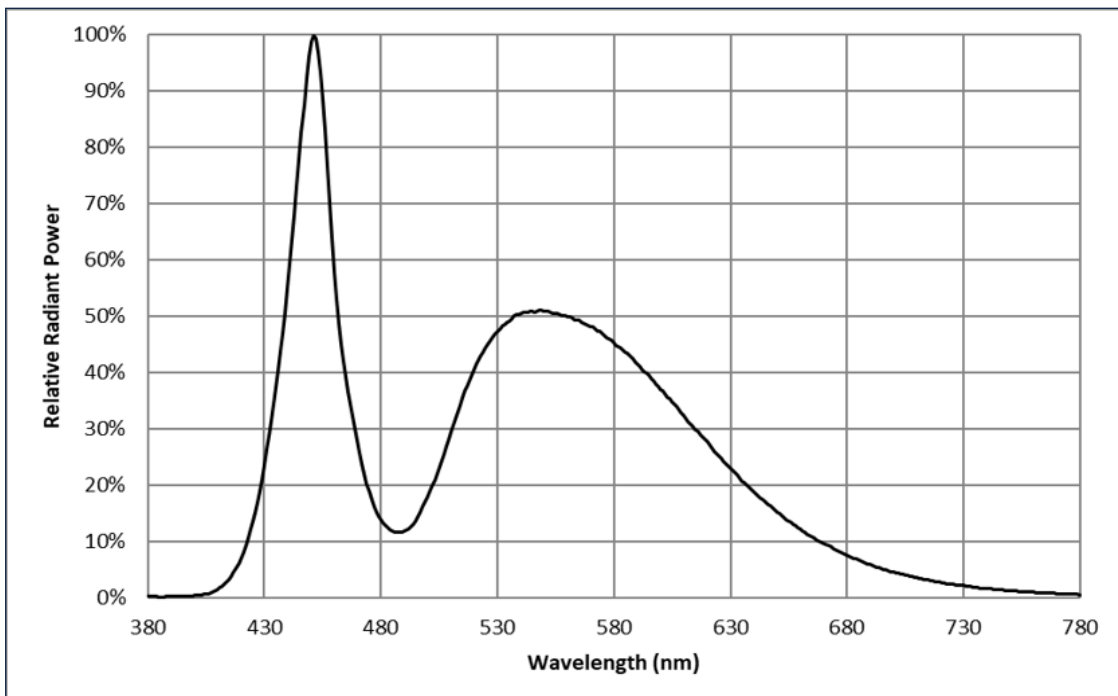
Angular Distribution

$I_f = 1.5 \text{ A}; T_j = 25^\circ\text{C}$



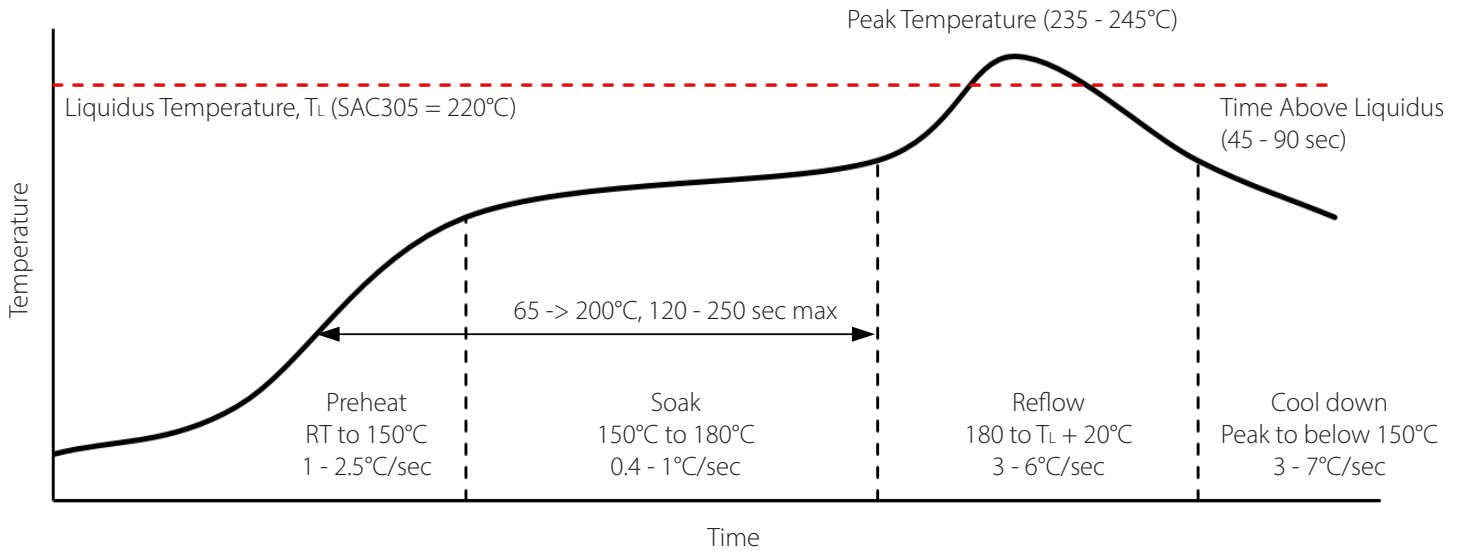
Relative Spectral Power Distribution

$I_f = 1.5 \text{ A}; T_j = 85^\circ\text{C}$





Soldering Profile



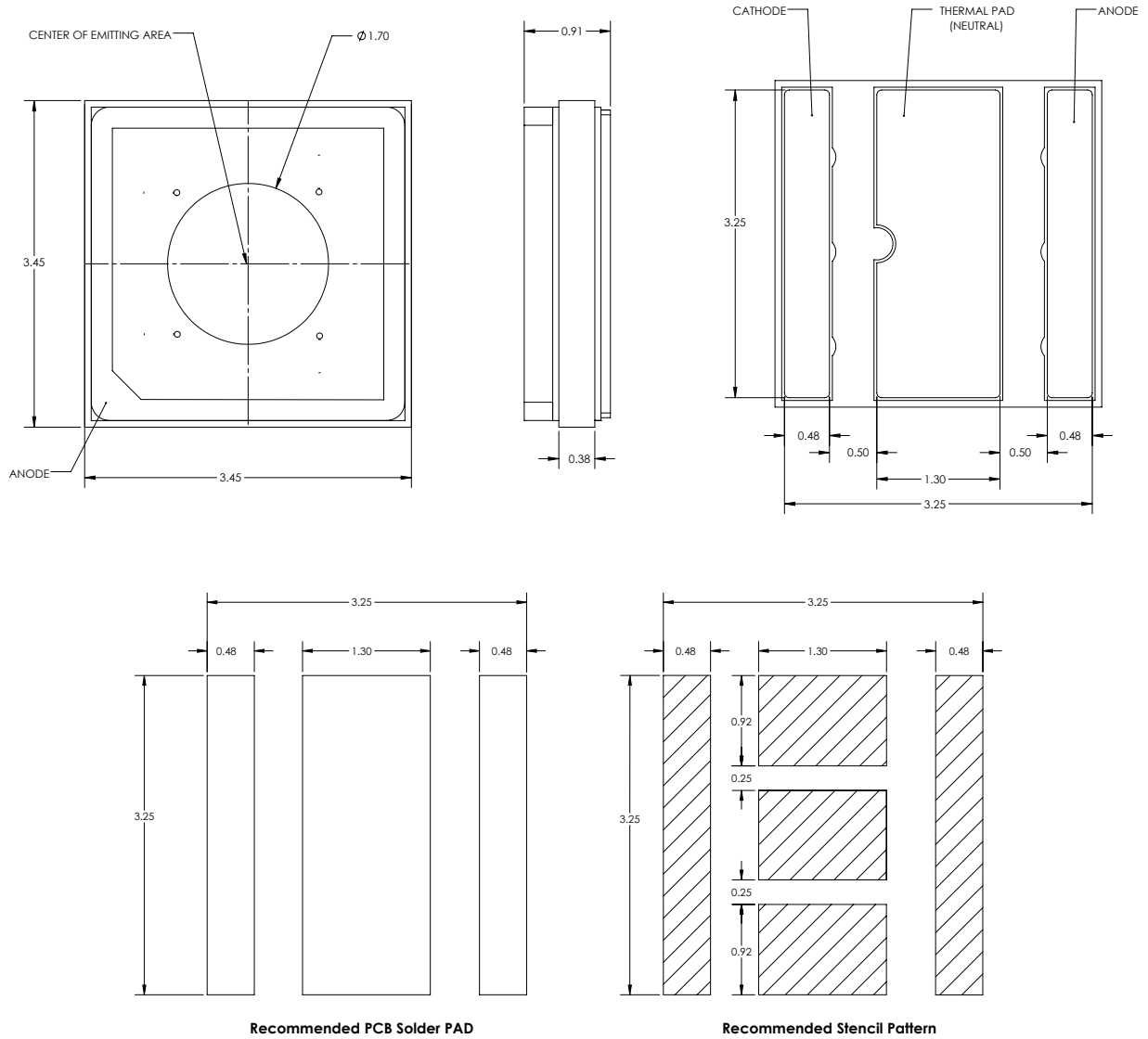
| SMT Rework Guideline | Manual Hotplate Reflow | Hot Air Gun Reflow |
|----------------------|------------------------|--------------------|
| Heating Time | | < 60 sec |
| Hotplate Temperature | < 245°C | < 150°C |

Note:

- Product complies to Moisture Sensitivity Level 3 (MSL 3).
- The numbers in the table are specific to SAC305. Luminus recommends using an SAC305 solder paste with a no-clean flux for RoHS compliant products.
- During the pick and place process, axial forces on the dome (or window) should not exceed 0.5 Newtons (N).
- Use of a multi-zone IR reflow oven with a nitrogen blanket is recommended.
- Time-temperature profile of the reflow process showing the four functional profile zones are defined in IPC-7801. Temperature is referenced to the center of the PCB.
- Luminus recommends to use the solder paste data sheet information as a starting point in time-temperature process development.
- These are general guidelines. Consult the solder paste manufacturer's datasheet for guidelines specific to the alloy and flux combination used in your application.
For more information, please refer to:
<https://luminusdevices.zendesk.com/hc/en-us/articles/360060306692-How-do-I-Reflow-Solder-Luminus-SMD-Components->
- For any technical questions about soldering process, please contact Luminus at techsupport@luminus.com.



Mechanical Dimensions¹

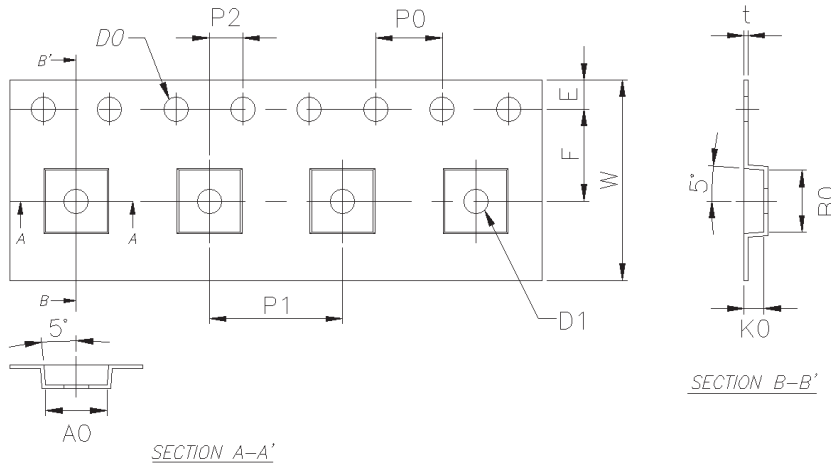


Note:

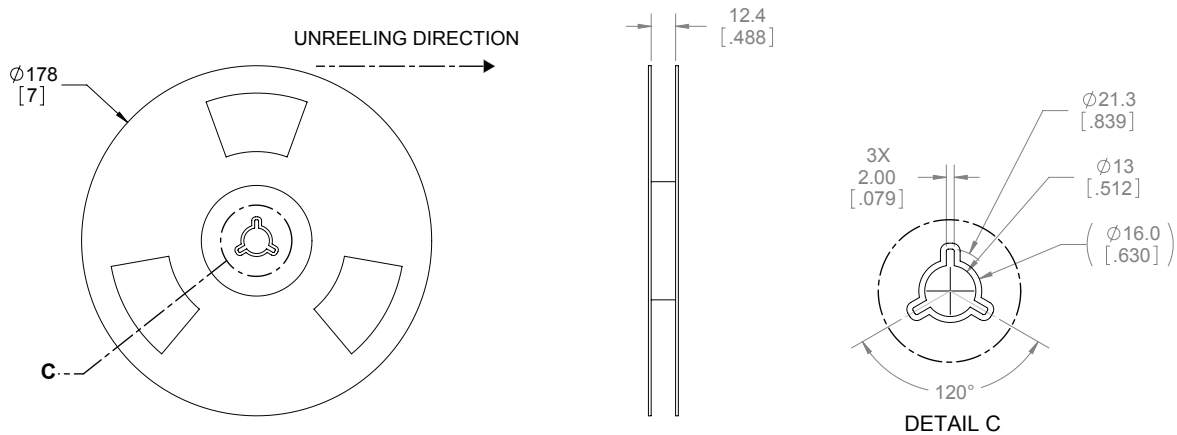
1. All dimensions are in millimeter ± 0.13 mm.



Tape and Reel Outline



| Parameter | Dimension (mm) |
|-----------|----------------|
| A0 | 3.70±0.10 |
| B0 | 3.70±0.10 |
| D0 | 1.50+0.10 |
| D1 | 1.50±0.10 |
| E | 1.75±0.10 |
| F | 5.50±0.10 |
| K0 | 1.20±0.10 |
| P0 | 4.00±0.10 |
| P1 | 8.00±0.10 |
| P2 | 2.00±0.10 |
| t | 0.23±0.05 |
| W | 12±0.3 |



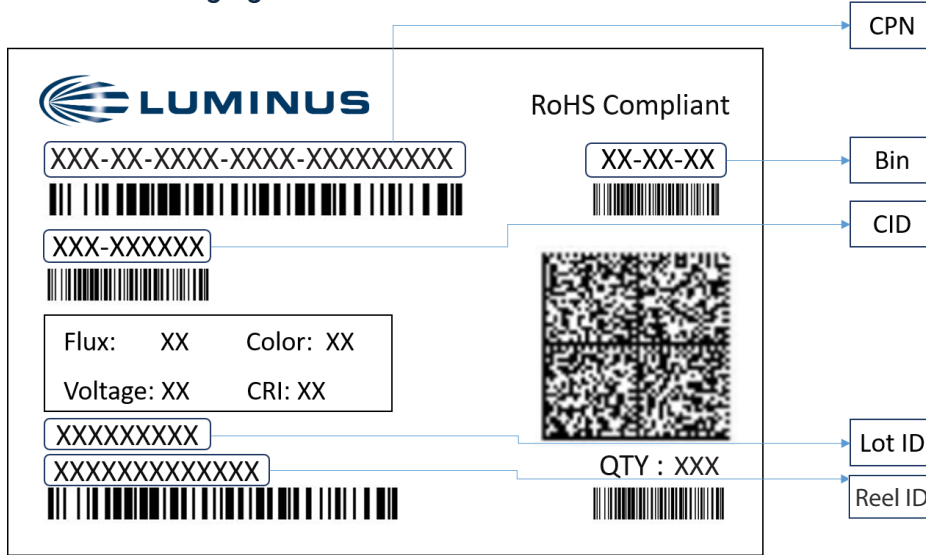
Note:

1. Each Reel contains 500 units of LEDs.
2. Black anti-static tape material (Denka ECM3/ECAP3)
3. The accumulated tolerance for ten chain holes should be no more than 0.2 mm.
4. The tortuosity of 250 mm tape should be no more than 1 mm.
5. Leave 800 mm of type empty for lead in (100 empty pockets)
6. Leave 1200 mm of type empty for trailer (150 empty pockets)
7. All dimensions must comply to EIA-481-D
8. Final tape and reel packaging must meet the requirements of JEDEC-STD-033, LEVEL 2A.



Shipping Label

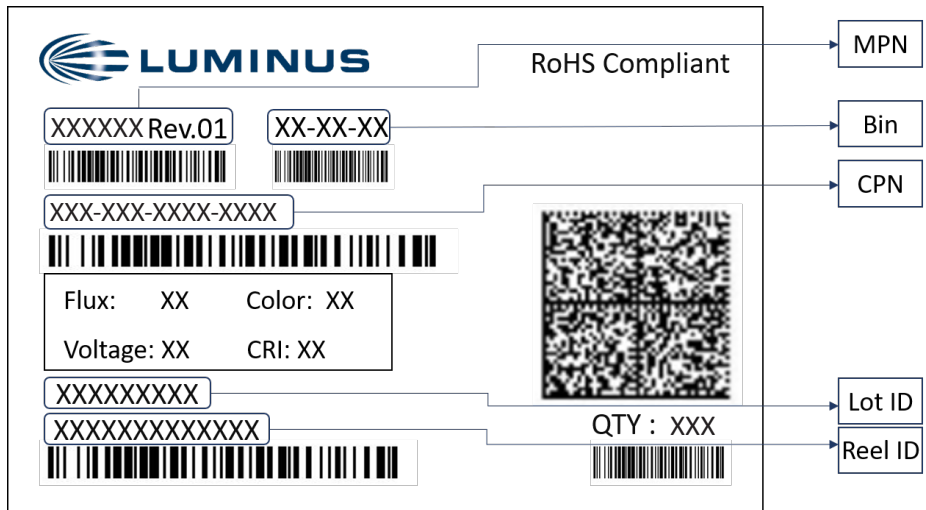
Label on Packaging Box



Label Fields:

- CPN:** Luminus ordering part number
- CID:** Customer's part number
- QTY:** Quantity of parts per reel
- Flux:** Bin as defined on page 3
- Voltage:** Bin as defined on page 3
- Color:** Bin as defined on page 4
- CRI:** NA
- Lot ID & Reel ID:** For Luminus internal use

Label on Reel



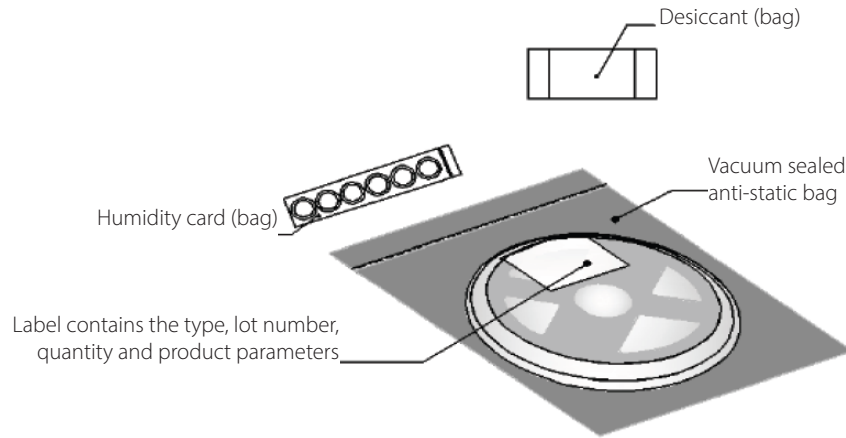
Label Fields:

- CPN:** Luminus ordering part number
- MPN:** For Luminus internal use
- QTY:** Quantity of parts per reel
- Flux:** Bin as defined on page 3
- Voltage:** Bin as defined on page 3
- Color:** Bin as defined on page 4
- CRI:** NA
- Lot ID & Reel ID:** For Luminus internal use



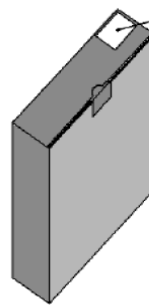
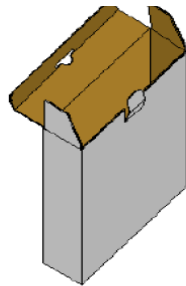
Packaging

Packaged Reel



Packaging boxes

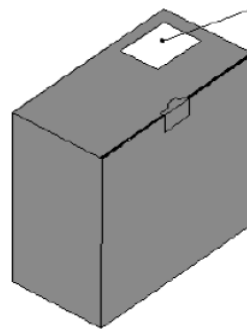
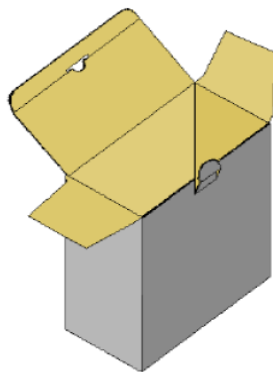
Box Size 1 - 5 reels per box
Size: 22.5 x 24.5 x 6.5 cm



Label contains the type, lot number, quantity and product parameters

*Capacity 5 reels per box

Box Size 2 - 10 reels per box
Size: 22.5 x 24.5 x 13 cm



Label contains the type, lot number, quantity and product parameters

**Capacity 10 reels per box

Packing Configuration:

- 500 units per reel
- Each reel is enclosed in anti-static bag
- Shipping label is placed on top of each reel
- Multiple labels are attached to the box (one label per reel inside the box)



Notes

Static Electricity

1. The products are sensitive to static electricity, and care should be taken when handling them.
2. Static electricity or surge voltage will damage the LEDs. It is recommended to wear anti-electrostatic gloves or wristband when handling the LEDs.
3. All devices, equipment and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

Reference: [APN-002815](#) Electrical Stress Damage to LEDs and How to Prevent It

Storage

1. Before opening the package

The LEDs should be kept at a temperature lower than 40°C and relative humidity lower than 90%. The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

2. After opening the package

The LEDs should be kept at a temperature lower than 30°C and relative humidity lower than 60%. The LEDs should be soldered within 168 hours (7 days) after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal it again.

If the moisture absorbent material (silica gel) vaporizes or passes the expiration date, baking treatment should be performed by using the following conditions : 60°C for 20 hours.

The LED's electrode and lead frame comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs to corrode or discolor. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.